

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

1t1963eq-1.5#trpbf

(Engineering Calculation)

DDPAK

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**TOTAL MASS (g) : 1.397065**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.003006	1000000	2151.6532031		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.828089	970000	592734.6875		
		Iron (Fe)	7439-89-6	0.022196	26000	15887.5917969		
		Phosphorus (P)	7723-14-0	0.000854	1000	611.281433105		
		Zinc (Zn)	7440-66-6	0.001281	1500	916.922119141		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.001281	1500	916.922119141		
<b>Lead Frame Total:</b>				<b>0.853701</b>	<b>1000000</b>	<b>611067.4375</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.009978	1000000	7142.27099609		
		<b>External Plating Total:</b>				<b>0.009978</b>	<b>1000000</b>	<b>7142.27099609</b>
		Inter. Plating Ni	7440-02-0	0.004000	740740.75	2863.14501953		
		Inter. Plating Ag	7440-22-4	0.001400	259259.265625	1002.10064697		
<b>Internal Plating Total:</b>				<b>0.005400</b>	<b>1000000</b>	<b>3865.24584961</b>		
Die Attach	95Pb / 5 Sn	Silver (Ag)	7440-22-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000080	50000	57.2628974915		
		Lead (Pb)	7439-92-1	0.001512	950000	1082.26879883		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000000	0	0		
<b>Die Attach Total:</b>				<b>0.001592</b>	<b>1000000</b>	<b>1139.53173828</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.053704	103000	38440.5859375		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.466653	895000	334023.78125		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.001043	2000	746.565063477		
		<b>Encapsulation Total:</b>				<b>0.521400</b>	<b>1000000</b>	<b>373210.90625</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.001988	1000000	1422.98303223		
					<b>TOTAL MASS (g) :</b>	<b>1.397065</b>		